

Features

- Lead Free Finish/Rohs Compliant (Note1) ("P" Suffix designates Compliant. See ordering information)
- Halogen free available upon request by adding suffix "-HF"
- For Surface Mount Applications
- Extremely Low Thermal Resistance
- Easy Pick And Place
- High Temp Soldering: 260°C for 10 Seconds At Terminals
- High Current Capability With Low Forward Voltage
- Epoxy meets UL 94 V-0 flammability rating
- Moisture Sensitivity Level 1

Maximum Ratings

- Operating Temperature: -55°C to +150°C
- Storage Temperature: -55°C to +150°C
- Maximum Thermal Resistance; 70°C/W Junction To Ambient

MCC Catalog Number	Device Marking	Maximum Recurrent Peak Reverse Voltage	Maximum RMS Voltage	Maximum DC Blocking Voltage
SS3150A		150V	105V	150V

Electrical Characteristics @ 25°C Unless Otherwise Specified

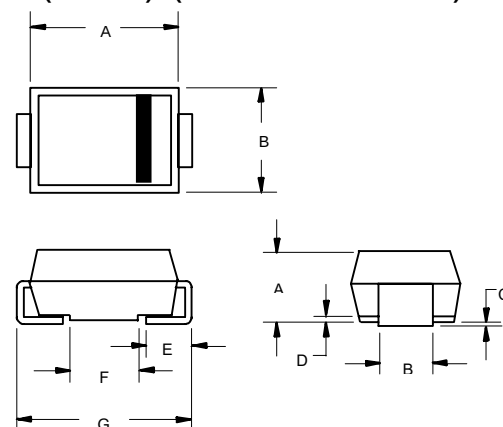
Average Forward Current	$I_{F(AV)}$	3.0A	$T_J = 120^\circ\text{C}$
Peak Forward Surge Current	I_{FSM}	80A	8.3ms, half sine
Maximum Instantaneous Forward Voltage	V_F	.90V	$I_{FM} = 3.0\text{A}; T_J = 25^\circ\text{C}^*$
Maximum DC Reverse Current At Rated DC Blocking Voltage	I_R	0.2mA 5.0mA	$T_C = 25^\circ\text{C}$ $T_C = 100^\circ\text{C}$
Typical Junction Capacitance	C_J	100pF	Measured at 1.0MHz, $V_R=4.0\text{V}$

*Pulse test: Pulse width 200 μsec , Duty cycle 2%

Note: 1. High Temperature Solder Exemptions Applied, see EU Directive Annex 7.

3 Amp Schottky Rectifier 150 Volts

DO-214AC (SMA) (LEAD FRAME)



DIMENSIONS					
DIM	INCHES		MM		NOTE
	MIN	MAX	MIN	MAX	
A	.079	.096	2.00	2.44	
B	.050	.064	1.27	1.63	
C	.002	.008	.05	.20	
D	---	.02	---	.51	
E	.030	.060	.76	1.52	
F	.065	.091	1.65	2.32	
G	.189	.220	4.80	5.59	
H	.157	.181	4.00	4.60	
J	.090	.115	2.25	2.92	

SUGGESTED SOLDER PAD LAYOUT

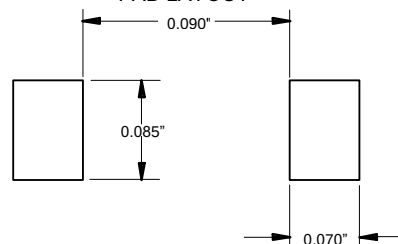


FIG. 1-TYPICAL FORWARD CURRENT DERATING CURVE

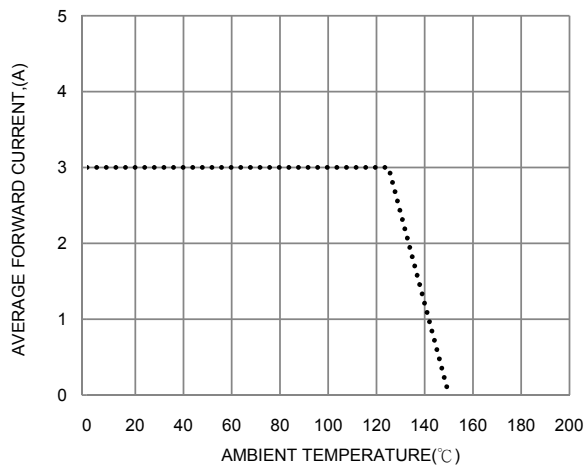


FIG. 2-TYPICAL FORWARD CHARACTERISTICS

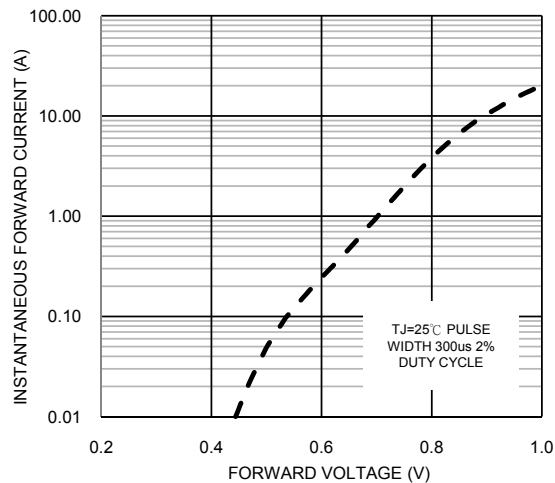


FIG. 3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

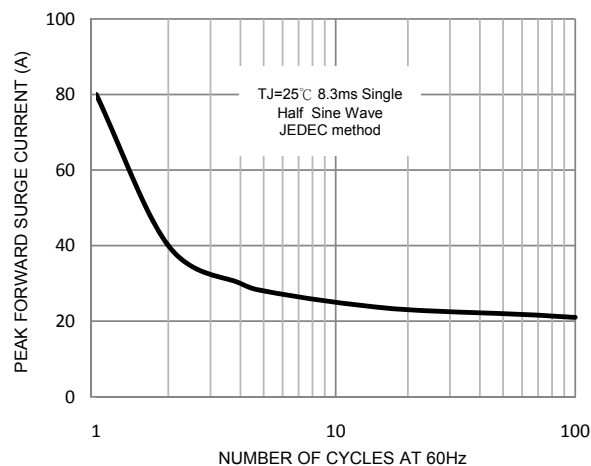


FIG. 4-TYPICAL REVERSE CHARACTERISTICS

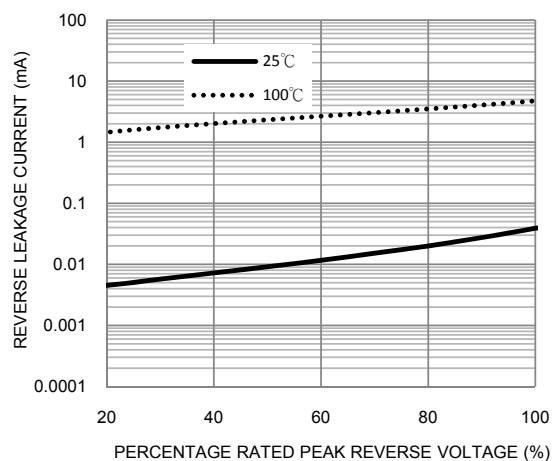


FIG. 5-TYPICAL JUNCTION CAPACITANCE

